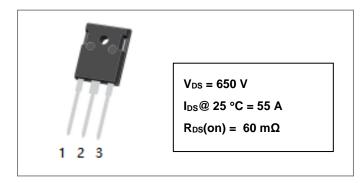
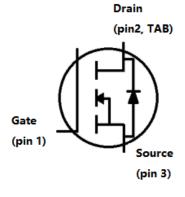


RoHS

S1M0060065D 650V Silicon Carbide Power MOSFET



Circuit Diagram



Description

S1M0060065D is a single SiC Power MOSFET packaged in a TO-247-3 case. The device is a high voltage n-channel enhancement mode MOSFET which has very low total conduction losses and very stable switching characteristics over temperature extremes. The S1M0060065D is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance typ. RDS(on) = 60 m Ω .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- Process of non-bright tin electroplating.
- "-A" is an AEC-Q101 qualified device.

Applications

- EV Fast Charging Modules
- EV On-Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)



RoHS

Maximum Ratings (T_A = 25 °C, unless otherwise specified)

| Characteristics | Symbol | Conditions | Min. | Тур. | Max. | Units | Note |
|---------------------------------|-----------------------|---|------|-------------|------|-------|------|
| Drain - Source Voltage | V _{DSmax} | V _{GS} = 0 V, I _D = 100 μA | | | 650 | V | |
| Gate - Source Voltage (dynamic) | V _{GSmax} | AC (f > 1 Hz) | -10 | | +25 | V | |
| Gate - Source Voltage (static) | V_{GSop} | Static | | -4 / +18 | | V | [1] |
| Continuous Drain Current | I _D | V _{GS} = 18 V, T _C = 25 °C | | 55 | | A | |
| | | V _{GS} = 18 V, T _C = 100 °C | | 39 | | A | |
| Pulsed Drain Current | I _{D(pulse)} | Pulse width t _P limited by T _{jmax} | | 99 | | А | |
| Power Dissipation | P _D | T _C = 25 °C | | 307 | | W | |

^[1] Recommended turn off gate voltage is -4 V. Recommended turn on gate voltage is 18 V. Do not use with V_{GSON} < 15 V.



RoHS

Electrical Characteristics (T_A = 25 °C, unless otherwise specified)

| Characteristics | Symbol | Conditions | Min. | Тур. | Max. | Units |
|-------------------------------------|----------------------|--|---------------------------------|------|------|-------|
| Drain Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 \text{ V}, I_{D} = 100 \mu\text{A}$ | 650 | | | V |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 5$ mA | 2 | 2.8 | 4 | V |
| | | V _{DS} = V _{GS} , I _D = 5 mA, T _J = 175 °C | | 2.1 | | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 650 V, V _{GS} = 0 V | | 1 | 100 | μΑ |
| Gate Source Leakage Current | I _{GSS} | V _{GS} = 18 V, V _{DS} = 0 V | | 10 | 250 | nA |
| Drain Source On-State Resistance | R _{DS(on)} | V _{GS} = 18 V, I _D = 15 A | 42 | 60 | 79 | Ω |
| | | V _{GS} = 18 V, I _D = 15 A, T _J = 175 °C | | 65 | | Ω |
| Transconductance | gfs | V _{DS} = 18 V, I _{DS} = 15 A | | 8 | | S |
| | | V _{DS} = 18 V, I _{DS} = 15 A, T _J = 175 °C | | 6 | | S |
| Input Capacitance | Ciss | V _G S = 0 V | | 1660 | | |
| Output Capacitance | Coss | V _{DS} = 650 V | | 139 | | pF |
| Reverse Transfer Capacitance | Crss | V _{AC} = 25 mV | | 9 | | |
| Coss Stored Energy | Eoss | f = 1 MHz | 13 | | | μJ |
| Turn-On Switching Energy | Eon | V _{DS} = 400 V, V _{GS} = -4 / 18 V | 94 | | | |
| Turn-Off Switching Energy | Eoff | $I_D = 15 \text{ A}, R_{G(ext)} = 2.5 \Omega, L = 99 \text{ uH}$ | | 21 | | μЈ |
| Turn-On Delay Time | t _{d(on)} | V _{DS} = 400 V, V _{GS} = -4 / 18 V | 28 | | | |
| Rise Time | t _r | $I_D = 15 \text{ A}, R_{G(ext)} = 2.5 \Omega$ | 15 A, $R_{G(ext)} = 2.5 \Omega$ | | | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | Inductive Load Timing relative to | 28 | | | |

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62.5



Total Gate Charge

Technical Data RoHS Data Sheet N2909, REV.-Fall Time VDS Per IEC60747-8-4 pg 83 10 t_f Internal Gate Resistance f = 1 MHz, AC = 25 mV2 Ω $R_{G(int)} \\$ V_{DS} = 400 V, V_{GS} = -4 / 18 V Gate to Source Charge \mathbf{Q}_{gs} 21.9 Gate to Drain Charge Q_{gd} $I_D = 15 A$ 20.3 nC

Per IEC60747-8-4 pg 21

Reverse Diode Characteristics (T_A = 25 °C, unless otherwise specified)

 Q_g

| Characteristics | Symbol | Conditions | Тур. | Max. | Units |
|----------------------------------|-----------------|--|------|------|-------|
| Diada Farward Valtaga | V_{SD} | V _{GS} = -4 V, I _{SD} = 7.5 A | 4.5 | | V |
| Diode Forward Voltage | V_{SD} | V _{GS} = -4 V, I _{SD} = 7.5 A, T _J = 175 °C | 4.0 | | V |
| Continuous Diode Forward Current | Is | V _{GS} = -4 V, T _C = 25 °C | 26 | | Α |
| Reverse Recovery Time | t _{rr} | V _{GS} = -4 V, I _{SD} = 15 A, T _J = 25 °C | 15 | | ns |
| Reverse Recovery Charge | Qrr | V _R = 400 V | 107 | | nC |
| Peak Reverse Recovery Current | I _{mm} | dif / dt = A / μs | 12 | | Α |

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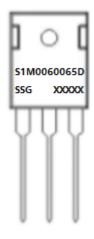
Thermal-Mechanical Specifications

| Characteristics | Symbol | Condition | Specification | Units |
|---|-------------------|--------------|---------------|-------|
| Junction Temperature | TJ | - | -55 to +175 | °C |
| Storage Temperature | T _{stg} | - | -55 to +175 | °C |
| Typical Thermal Resistance Junction to Case | R _θ JC | DC operation | 0.49 | °C/W |

Ordering Information

| Device | Package | Shipping |
|-------------|----------|--------------|
| S1M0060065D | TO-247-3 | 30pcs / tube |

Marking Diagram



Where XXXXX is YYWWL

S1M = Device Type $0060 = R_{DS}(on)$

065 = Reverse Voltage (1700V)

D = Package
 SSG = SSG
 YY = Year
 WW = Week
 L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

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Ratings and Characteristics Curves

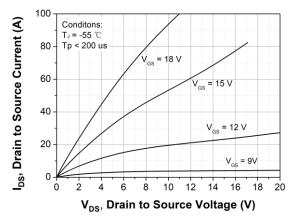


Figure 1. Output Characteristics T_J = -55 °C

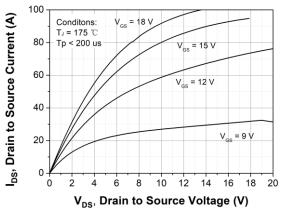


Figure 3. Output Characteristics T_J = 175 °C

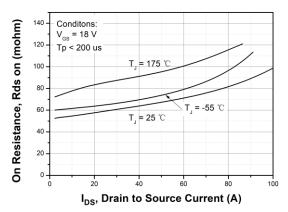


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

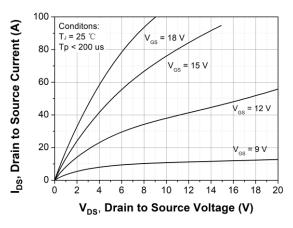


Figure 2. Output Characteristics T_J = 25 °C

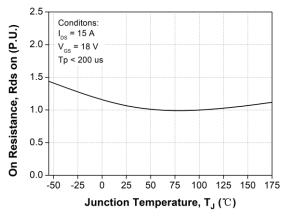


Figure 4. Normalized On-Resistance vs. Temperature

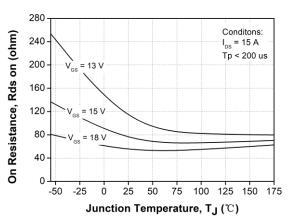


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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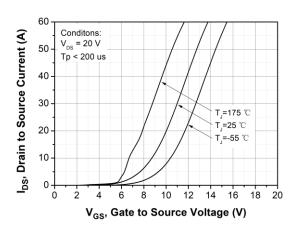


Figure 7. Transfer Characteristic for Various Junction Temperatures

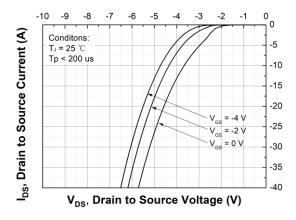


Figure 9. Body Diode Characteristic at T_J = 25 °C

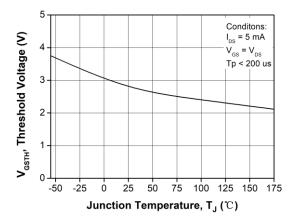


Figure 11. Threshold Voltage vs. Temperature

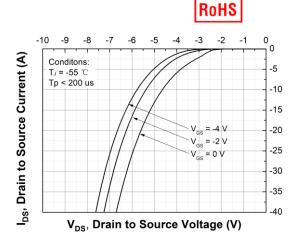


Figure 8. Body Diode Characteristic at T_J = -55 °C

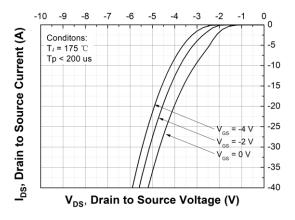


Figure 10. Body Diode Characteristic at T_J = 175 °C

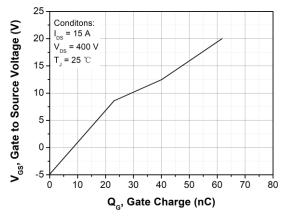


Figure 12. Gate Charge Characteristic

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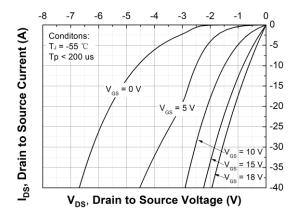


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C

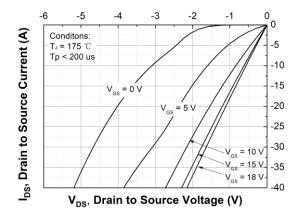


Figure 15. 3rd Quadrant Characteristic at T_J = 175 °C

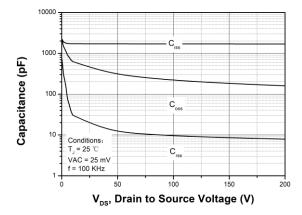


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200 V)

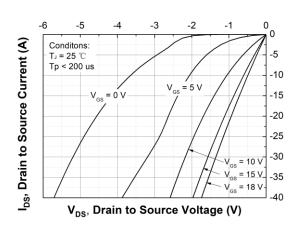


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

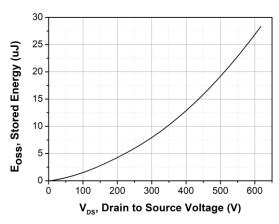


Figure 16. Output Capacitor Stored Energy

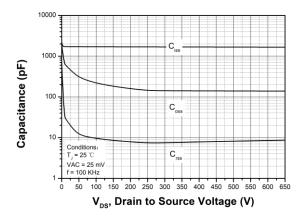


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650 V)

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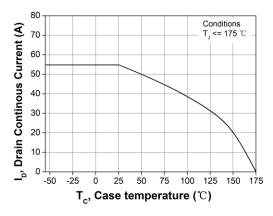


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

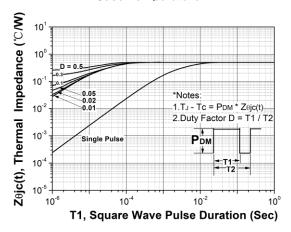


Figure 21. Transient Thermal Impedance (Junction - Case)

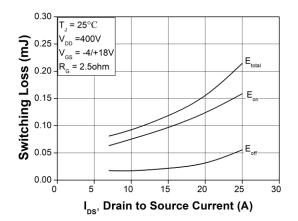


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (VDD = 400V)

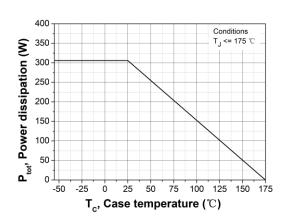


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

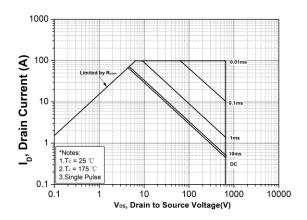


Figure 22. Safe Operating Area

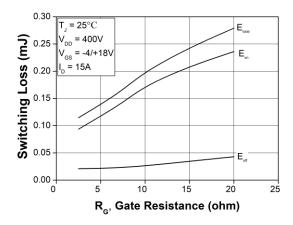


Figure 24. Clamped Inductive Switching Energy vs. R_{G(ext)}

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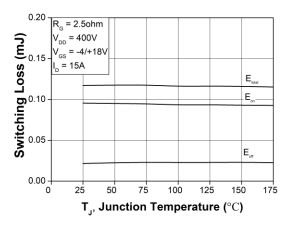


Figure 25. Clamped Inductive Switching Energy vs.
Temperature

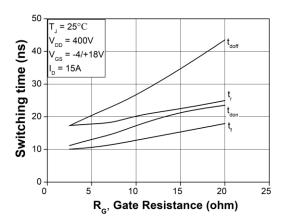
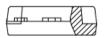


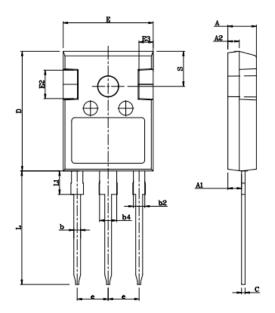
Figure 26. Switching Times vs. R_{G(ext)}

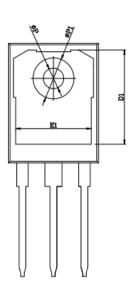




Mechanical Dimensions TO-247-3







COMMON DIMENSIONS

| SYMBOL | mm | | | | |
|----------|-----------|-------|-------|--|--|
| S I MBOL | Min | Nom | Max | | |
| A | 4.80 | 5.00 | 5.20 | | |
| Al | 2.23 | 2.41 | 2.59 | | |
| A2 | 1.85 | 2.00 | 2.15 | | |
| ь | 1.11 | 1.21 | 1.36 | | |
| b2 | 1.91 | 2.01 | 2,21 | | |
| b4 | 2.91 | 3.01 | 3.21 | | |
| с | 0.51 | 0.61 | 0.75 | | |
| D | 20.80 | 21.00 | 21.30 | | |
| Dl | 16.25 | 16.55 | 16.85 | | |
| Е | 15.50 | 15.80 | 16.10 | | |
| E1 | 13.00 | 13.26 | 13.56 | | |
| E2 | 4.80 | 5.00 | 5.20 | | |
| E3 | 2.30 2.50 | | 2.70 | | |
| e | 5.44BSC | | | | |
| L | 19.82 | 19.92 | 20.22 | | |
| L1 | 3.94 | 4.12 | 4.30 | | |
| ØP | 3.40 | 3.60 | 3.80 | | |
| ØP1 | 7.08 | 7.19 | 7.30 | | |
| S | 6.15BSC | | | | |





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